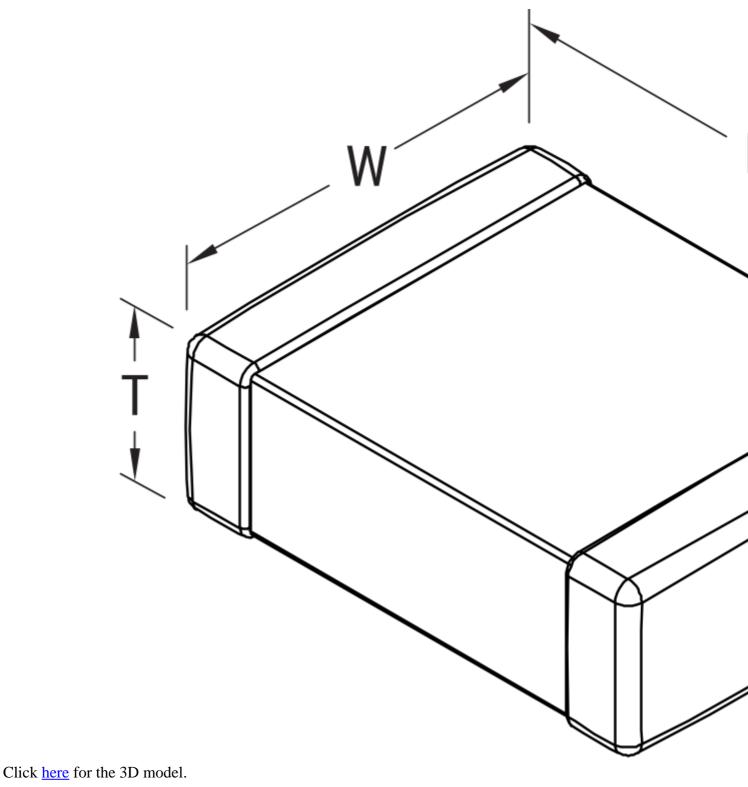
C1206J225K3RACTU

Aliases (C1206J225K3RAC7800)

SMD Comm X7R FO, Ceramic, 2.2 uF, 10%, 25 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1206



Chip Size 1206 L 3.3mm +/-0.4mm

Dimensions

W 1.6mm +/-0.35mm

T 1.6mm +/-0.20mm

B 0.6mm +/-0.25mm

Packaging Specifications

Packaging T&R, 180mm, Plastic Tape

Packaging Quantity 2000

General Information

Series	SMD Comm X7R FO	
Style	SMD Chip	
Description	SMD, MLCC, Open Mode, Temperature Stable	
Features	Open Mode, Temperature Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Component Weight 41 mg		
Shelf Life	78 Weeks	
MSL	1	

Specifications		
Capacitance	2.2 uF	
Measurement Condition	1 kHz 1.0Vrms	
Capacitance Tolerance	10%	
Voltage DC	25 VDC	
Dielectric Withstanding Voltage	62.5 VDC	
Temperature Range	-55/+125°C	
Temperature Coefficient	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms	
Dissipation Factor	10% 1 kHz 1.0Vrms	
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	227.3 MOhms	

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